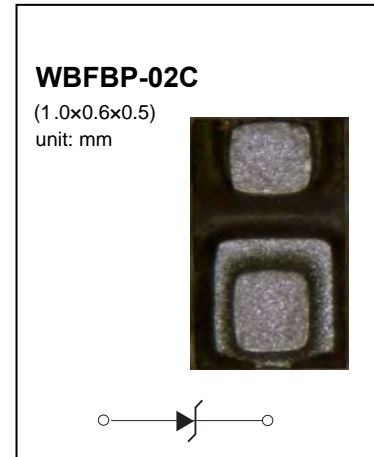


Transient Voltage Suppressors for ESD Protection
DESCRIPTION

The SESDxxxWB SERIES is designed to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space is at a premium.

FEATURES

- Stand-off Voltage: 3.3 V–12 V
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 KV) per Human Body Model
- IEC61000–4–2 Level 4 ESD Protection
- These are Pb–Free Devices
- **Pb-Free package is available**
RoHS product for packing code suffix "G"
Halogen free product for packing code suffix "H"


Maximum Ratings @Ta=25°C

Parameter	Symbol	Limit	Unit
IEC61000–4–2(ESD) Contact		±30	KV
ESD Voltage	Per Human Body Model	16	KV
	Per Machine Model	400	V
Total Power Dissipation on FR-5 Board (Note 1)	P_D	100	mW
Thermal Resistance Junction–to–Ambient	R _{OJA}	1250	°C/W
Lead Solder Temperature – Maximum (10 Second Duration)	T_L	260	°C
Junction and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150	°C

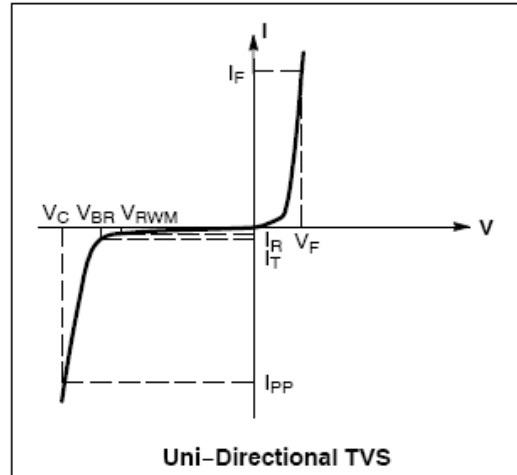
Stresses exceeding maximum ratings may damage the device. Maximum ratings are stress ratings only.

Functional operation above the recommended. Operating conditions is not implied. Extended exposure to stresses above the recommended operating conditions may affect device reliability.

1. FR-5 = 1.0 x 0.75 x 0.62 in.

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ELECTRICAL CHARACTERISTICS (Ta = 25°C unless otherwise noted)

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_F	Forward Current
V_F	Forward Voltage @ I_F
P_{pk}	Peak Power Dissipation
C	Max. Capacitance @ $V_R=0$ and $f=1\text{MHz}$


ELECTRICAL CHARACTERISTICS (Ta = 25°C unless otherwise noted, $V_F = 0.9\text{ V Max. @ } I_F = 10\text{mA}$ for all types)

Device*	Device Marking	V_{RWM} (V)	I_R (μA) @ V_{RWM}	V_{BR} (V) @ I_T (Note 2)		I_T	Max I_{PP} (A) (Note 3)	V_C (V) @Max I_{PP} (A) (Note 3)	P_{pk} (W) (8 x 20 μs)	C (pF)
		Max	Max	Min	Max		mA	-	Max	Typ
SESD3V3WB	A	3.3	1.0	5.0	5.9	1.0	9.8	11.4	102	80
SESD5V0WB	B	5.0	1.0	6.2	7.3	1.0	8.7	12.3	107	65
SESD7V0WB	X7	7.0	1.0	7.5	8.7	1.0	8.0	15.1	115	55
SESD12VWB	C	12	1.0	13.5	15.6	1.0	5.9	23.7	140	30

*Other voltages available upon request.

- V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C.
- Surge current waveform per Figure 3.